FAIRCHILD Semiconductor TM

FDV301N Digital FET , N-Channel

General Description

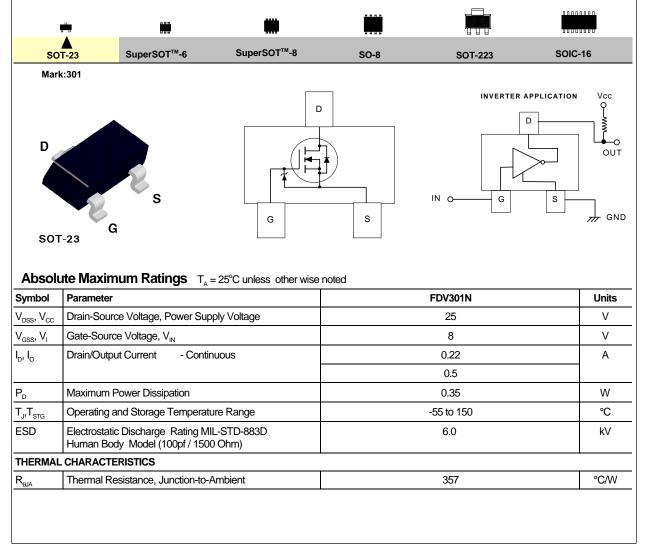
This N-Channel logic level enhancement mode field effect transistor is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, this one N-channel FET can replace several different digital transistors, with different bias resistor values.

Features

- 25 V, 0.22 A continuous, 0.5 A Peak. $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 V$ $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 V.$
- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.5V.

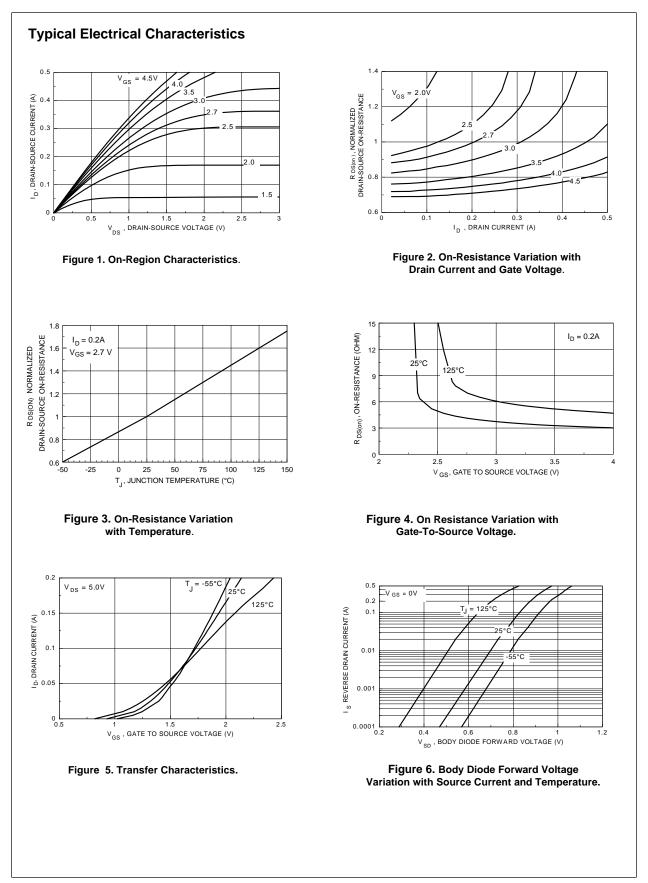
March 1999

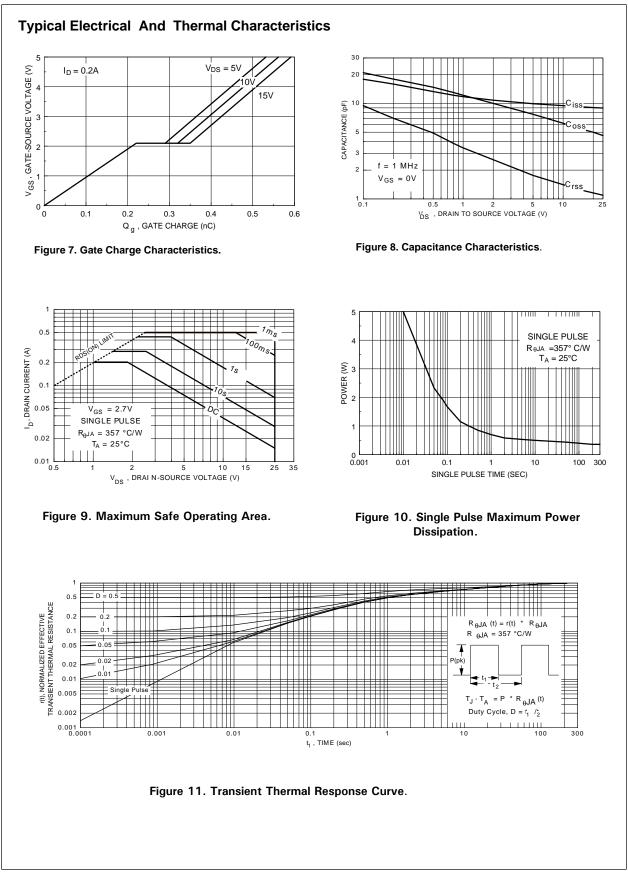
- Gate-Source Zener for ESD ruggedness.
 >6kV Human Body Model
- Replace multiple NPN digital transistors with one DMOS FET.



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Symbol	Parameter	Conditions	Min	Тур	Max	Units
I _{O (off)}	Zero Input Voltage Output Current	$V_{cc} = 20 V, V_{l} = 0 V$			1	μA
V _{I (off)}	Input Voltage	$V_{cc} = 5 V, I_{o} = 10 \mu A$			0.5	V
V _{I (on)}		$V_0 = 0.3 \text{ V}, I_0 = 0.005 \text{ A}$	1			V
R _{O (on)}	Output to Ground Resistance	$V_1 = 2.7 \text{ V}, \ I_0 = 0.2 \text{ A}$		4	5	Ω
Electric	al Characteristics (T _A = 25 °C unless	s otherwise noted)				
Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAF	RACTERISTICS	- 1				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{gs} = 0 V, I_{p} = 250 \mu A$	25			V
$\Delta BV_{DSS}/\Delta T_{c}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		25		mV / °C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA
		T _{.1} = 55°C			10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
	CTERISTICS (Note)		1	1	1	
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250 \ \mu$ A, Referenced to $25 \ ^{\circ}C$		-2.1		mV/°C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.65	0.85	1.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 2.7 \text{ V}, I_{D} = 0.2 \text{ A}$		3.8	5	Ω
		T, =125°C		6.3	9	
		$V_{\rm GS} = 4.5 \text{ V}, \ I_{\rm D} = 0.4 \text{ A}$		3.1	4	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$	0.2			А
9 _{FS}	Forward Transconductance	$V_{\rm DS} = 5 \text{ V}, \text{ I}_{\rm D} = 0.4 \text{ A}$		0.2		S
DYNAMIC (CHARACTERISTICS				1	
C _{iss}	Input Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V,$		9.5		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		6		pF
C _{rss}	Reverse Transfer Capacitance	—		1.3		pF
SWITCHING	G CHARACTERISTICS (Note)					•
t _{D(on)}	Turn - On Delay Time	$V_{_{DD}} = 6 V, \ I_{_{D}} = 0.5 A,$		3.2	8	ns
t,	Turn - On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 50 Ω		6	15	ns
t _{D(off)}	Turn - Off Delay Time			3.5	8	ns
t,	Turn - Off Fall Time			3.5	8	ns
С [°]	Total Gate Charge	$V_{DS} = 5 V, I_{D} = 0.2 A,$ $V_{GS} = 4.5 V$		0.49	0.7	nC
Q_{gs}	Gate-Source Charge			0.22		nC
Q _{gd}	Gate-Drain Charge			0.07		nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND MAXIMU	JM RATINGS	-			1
l _s	Maximum Continuous Drain-Source Diode Forward Current				0.29	А
V _{SD}	Drain-Source Diode Forward Voltage $V_{GS} = 0 V, I_S = 0.29 A$ (Note)			0.8	1.2	V





FDV301N Rev.F

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